

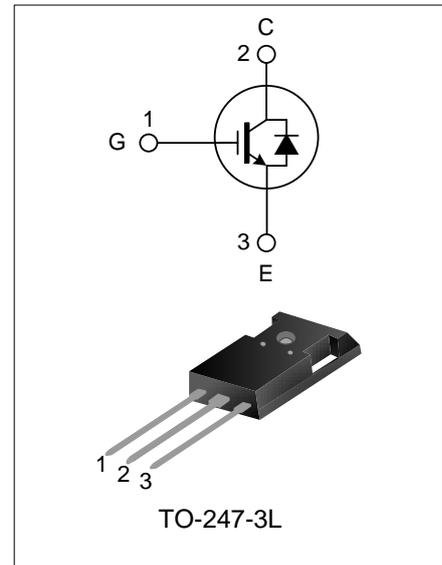
## 75A, 650V FIELD STOP IGBT

### DESCRIPTION

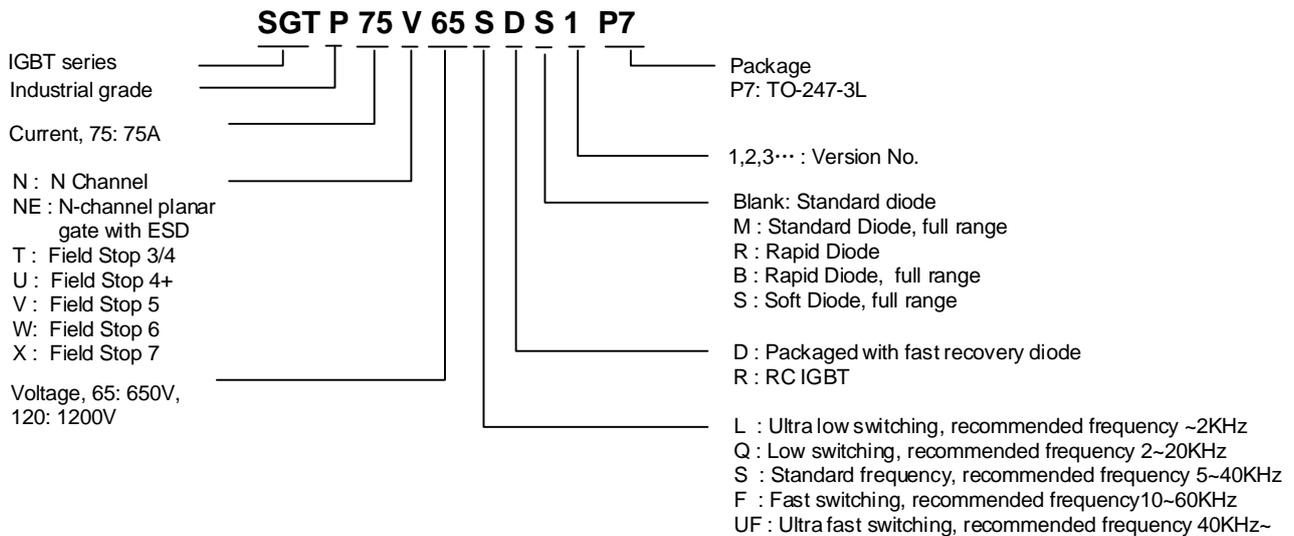
The SGTP75V65SDS1P7 field stop IGBT adopts Silan Field Stop V technology, features low conduction loss and switching loss. This device is applicable to photovoltaic, UPS, SMPS, and PFC fields.

### FEATURES

- ◆ 75A, 650V,  $V_{CE(sat)(typ.)}=1.42V@I_C=75A$
- ◆ Low conduction loss
- ◆ Ultra-fast switching
- ◆ High input impedance
- ◆  $T_{Jmax.}=175^{\circ}C$



### NOMENCLATURE



### ORDERING INFORMATION

Part No.	Package	Marking	Hazardous Substance Control	Packing Type
SGTP75V65SDS1P7	TO-247-3L	P75V65SDS1	Halogen free	Tube

**ABSOLUTE MAXIMUM RATINGS (UNLESS OTHERWISE NOTED,  $T_C=25^\circ\text{C}$ )**

Characteristics	Symbol	Ratings	Unit
Collector to Emitter Voltage	$V_{CE}$	650	V
Gate to Emitter Voltage	$V_{GE}$	$\pm 20$	V
Transient Gate to Emitter Voltage ( $t_p \leq 10\mu\text{s}$ , $D < 0.010$ )	$V_{GE}$	$\pm 30$	V
Collector Current	$I_C$	$T_C=25^\circ\text{C}$	150
		$T_C=100^\circ\text{C}$	75
Pulsed Collector Current	$I_{CM}$	300	A
Diode Current	$I_F$	$T_C=25^\circ\text{C}$	150
		$T_C=100^\circ\text{C}$	75
Diode Pulsed Current	$I_{FM}$	300	A
Power Dissipation ( $T_C=25^\circ\text{C}$ )	$P_D$	395	W
Operating Junction Temperature	$T_J$	$-40 \sim +175$	$^\circ\text{C}$
Storage Temperature Range	$T_{stg}$	$-55 \sim +150$	$^\circ\text{C}$

**THERMAL CHARACTERISTICS**

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Thermal Resistance, Junction to Case (IGBT)	$R_{\theta JC}$	--	--	--	0.38	$^\circ\text{C/W}$
Thermal Resistance, Junction to Case (FRD)	$R_{\theta JC}$	--	--	--	0.6	$^\circ\text{C/W}$
Thermal Resistance, Junction to Ambient (IGBT)	$R_{\theta JA}$	--	--	--	40	$^\circ\text{C/W}$
Soldering Temperature (in line)	$T_{sold}$	$15_{-0}^{+2}$ sec, 1time	--	--	260	$^\circ\text{C}$

**ELECTRICAL CHARACTERISTICS OF IGBT (UNLESS OTHERWISE NOTED,  $T_C=25^\circ\text{C}$ )**

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Collector to Emitter Breakdown Voltage	$BV_{CE}$	$V_{GE}=0V, I_C=250\mu A$	650	--	--	V
C-E Leakage Current	$I_{CES}$	$V_{CE}=650V, V_{GE}=0V$	--	--	50	$\mu A$
G-E Leakage Current	$I_{GES}$	$V_{GE}=20V, V_{CE}=0V$	--	--	$\pm 100$	nA
G-E Threshold Voltage	$V_{GE(th)}$	$I_C=250\mu A, V_{CE}=V_{GE}$	3.4	4.0	5.0	V
Collector to Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=75A, V_{GE}=15V, T_C=25^\circ\text{C}$	--	1.42	1.85	V
		$I_C=75A, V_{GE}=15V, T_C=175^\circ\text{C}$	--	1.76	--	V
Input Capacitance	$C_{ies}$	$V_{CE}=30V$	--	4914	--	pF
Output Capacitance	$C_{oes}$	$V_{GE}=0V$	--	182	--	
Reverse Transfer Capacitance	$C_{res}$	$f=1\text{MHz}$	--	20	--	
Turn-On Delay Time	$T_{d(on)}$	$V_{CE}=400V$ $I_C=75A$ $R_g=10\Omega$ $V_{GE}=15V$ inductive load $T_C=25^\circ\text{C}$	--	36	--	ns
Rise Time	$T_r$		--	63	--	
Turn-Off Delay Time	$T_{d(off)}$		--	218	--	
Fall Time	$T_f$		--	71	--	
Turn-On Switching Loss	$E_{on}$		$T_C=25^\circ\text{C}$	--	1.06	--
Turn-Off Switching Loss	$E_{off}$	--		1.10	--	
Total Switching Loss	$E_{st}$	--		2.26	--	
Turn-On Delay Time	$T_{d(on)}$	$V_{CE}=400V$ $I_C=37.5A$ $R_g=10\Omega$ $V_{GE}=15V$ inductive load $T_C=25^\circ\text{C}$	--	31	--	ns
Rise Time	$T_r$		--	25	--	
Turn-Off Delay Time	$T_{d(off)}$		--	221	--	
Fall Time	$T_f$		--	39	--	
Turn-On Switching Loss	$E_{on}$		$T_C=25^\circ\text{C}$	--	0.48	--
Turn-Off Switching Loss	$E_{off}$	--		0.57	--	
Total Switching Loss	$E_{st}$	--		1.05	--	
Total Gate Charge	$Q_g$	$V_{CE}=520V, I_C=75A, V_{GE}=15V$	--	181	--	nC
Gate to Emitter Charge	$Q_{ge}$		--	38	--	
Gate to Collector Charge	$Q_{gc}$		--	48	--	

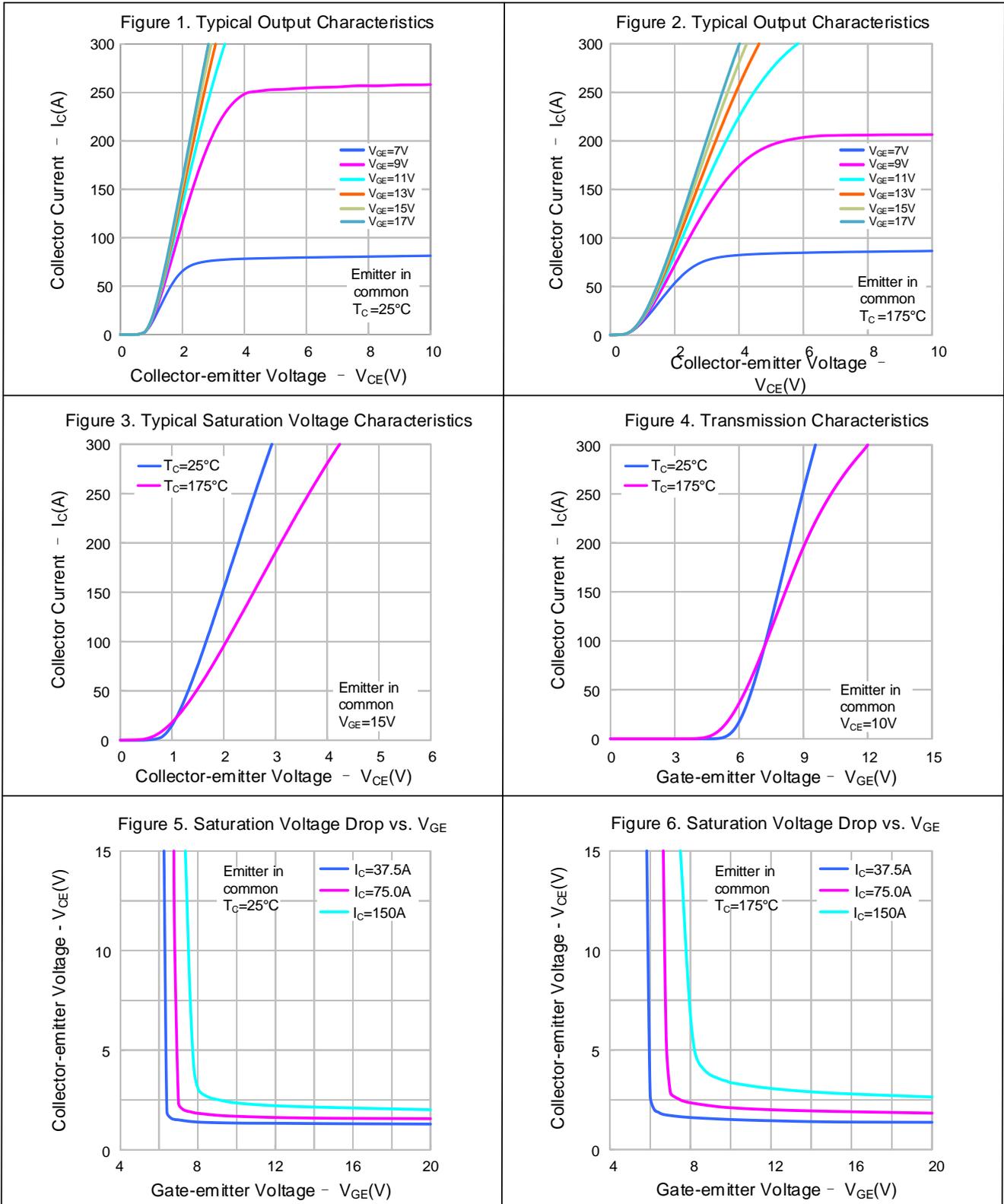
**ELECTRICAL CHARACTERISTICS OF FRD (UNLESS OTHERWISE NOTED,  $T_C=25^\circ\text{C}$ )**

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Diode Forward Voltage	$V_{FM}$	$I_F=75A, T_C=25^\circ\text{C}$	--	1.65	2.0	V
		$I_F=75A, T_C=175^\circ\text{C}$	--	1.55	--	
Diode Reverse Recovery Time	$T_{rr}$	$I_{ES}=75A, di_{ES}/dt=200A/\mu s,$ $T_C=25^\circ\text{C}$	--	61	--	ns
Diode Reverse Recovery Charge	$Q_{rr}$		--	0.20	--	nC
Diode Reverse Recovery Current	$I_{rrm}$		--	6.3	--	A

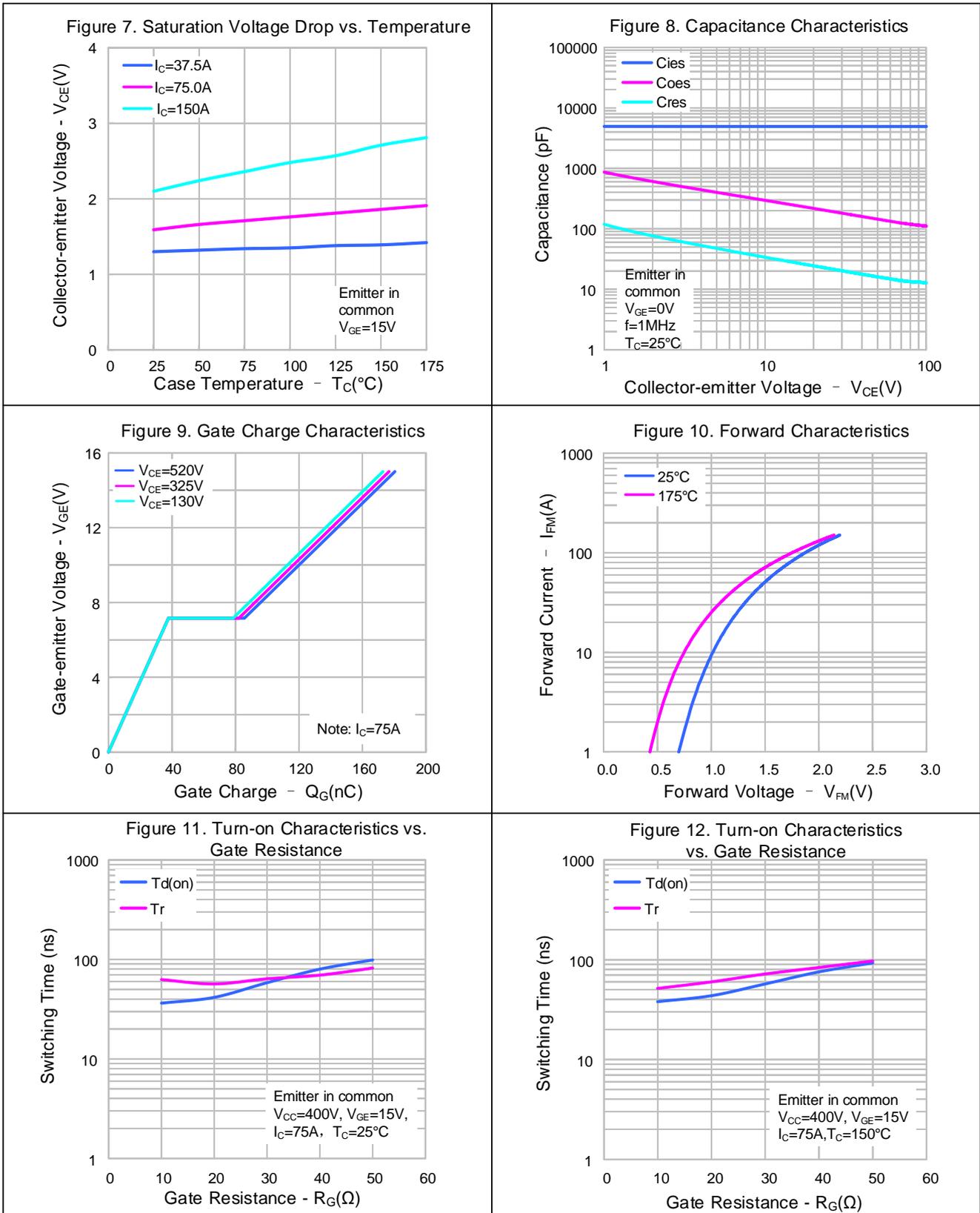
**ELECTRICAL CHARACTERISTICS OF IGBT (UNLESS OTHERWISE NOTED,  $T_C=150^{\circ}\text{C}$ )**

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Turn-On Delay Time	$T_{d(on)}$	$V_{CE}=400\text{V}$ $I_C=75\text{A}$ $R_g=10\Omega$ $V_{GE}=15\text{V}$ inductive load $T_C=150^{\circ}\text{C}$	--	38	--	ns
Rise Time	$T_r$		--	52	--	
Turn-Off Delay Time	$T_{d(off)}$		--	235	--	
Fall Time	$T_f$		--	74	--	
Turn-On Switching Loss	$E_{on}$	$T_C=150^{\circ}\text{C}$	--	1.44	--	mJ
Turn-Off Switching Loss	$E_{off}$		--	1.60	--	
Total Switching Loss	$E_{st}$		--	3.04	--	
Turn-On Delay Time	$T_{d(on)}$	$V_{CE}=400\text{V}$ $I_C=37.5\text{A}$ $R_g=10\Omega$ $V_{GE}=15\text{V}$ inductive load $T_C=150^{\circ}\text{C}$	--	34	--	ns
Rise Time	$T_r$		--	30	--	
Turn-Off Delay Time	$T_{d(off)}$		--	246	--	
Fall Time	$T_f$		--	72	--	
Turn-On Switching Loss	$E_{on}$	$T_C=150^{\circ}\text{C}$	--	0.60	--	mJ
Turn-Off Switching Loss	$E_{off}$		--	0.86	--	
Total Switching Loss	$E_{st}$		--	1.46	--	

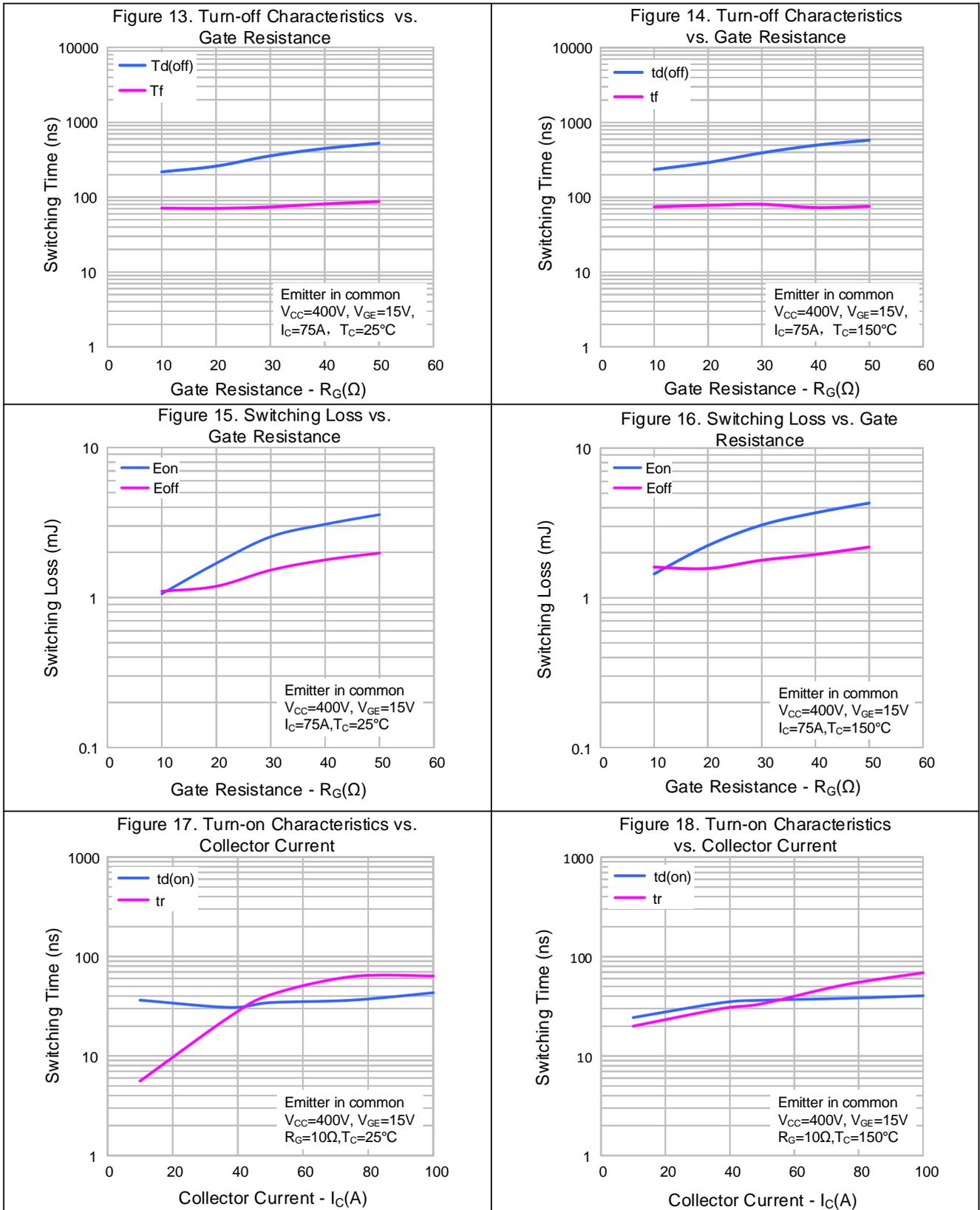
**TYPICAL CHARACTERISTICS**



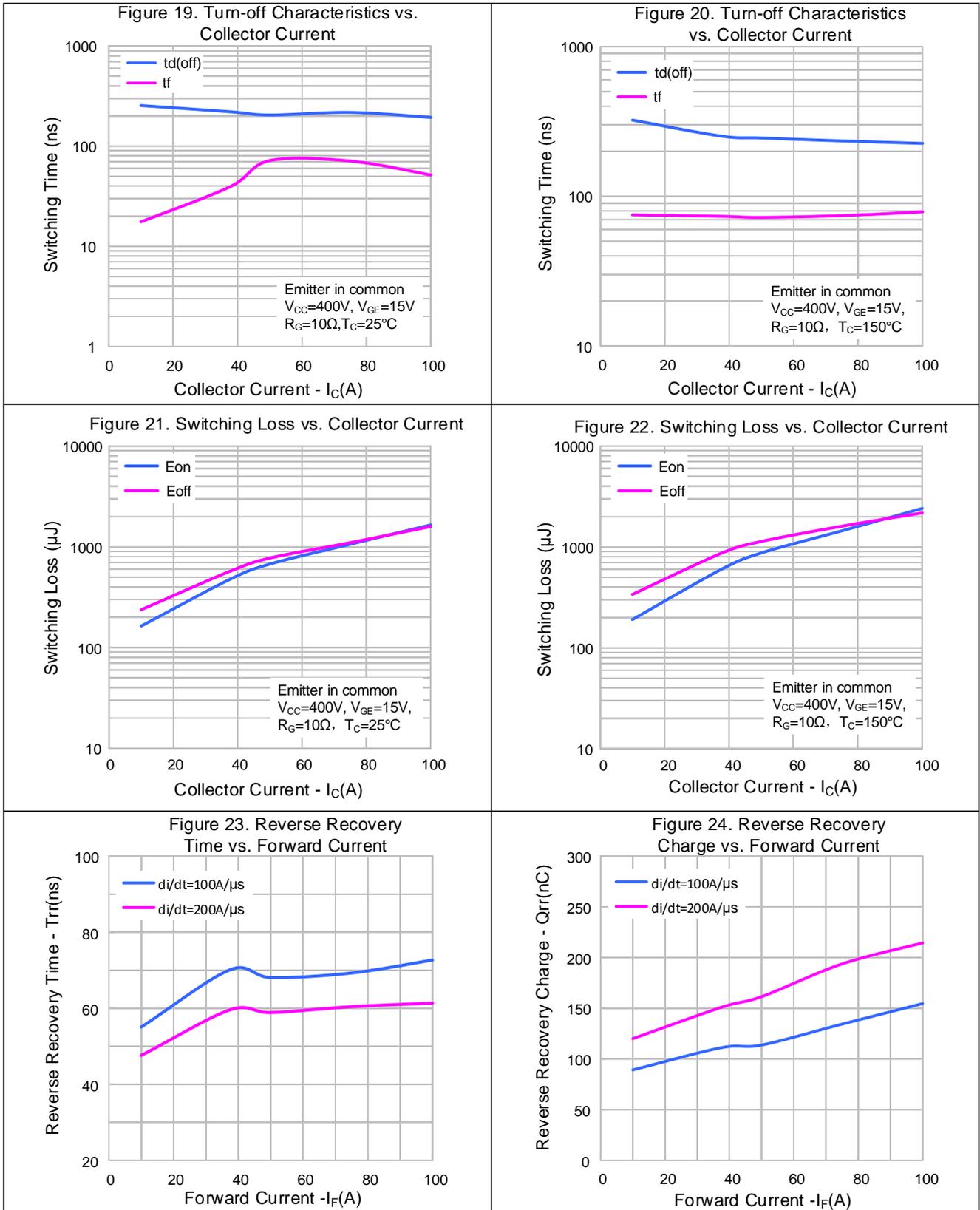
**TYPICAL CHARACTERISTICS (CONTINUED)**



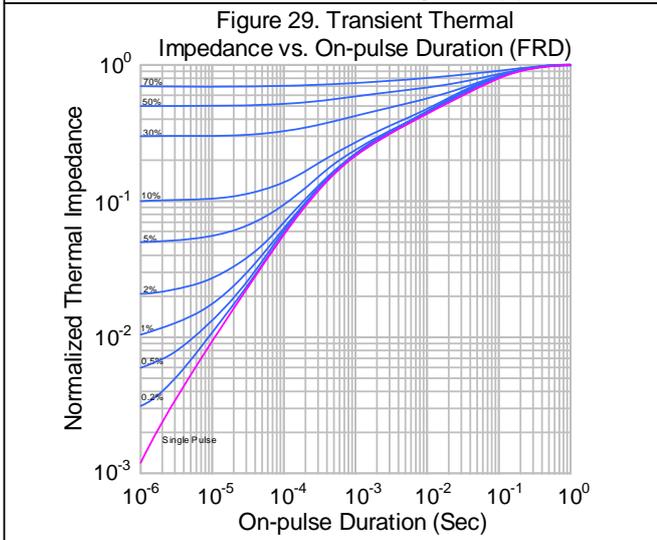
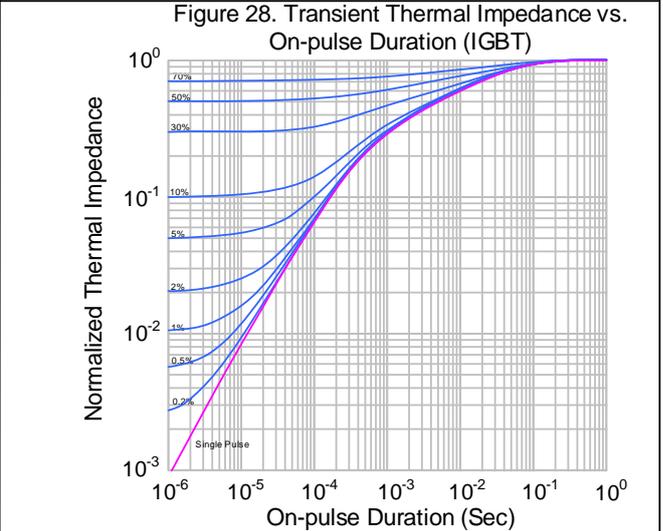
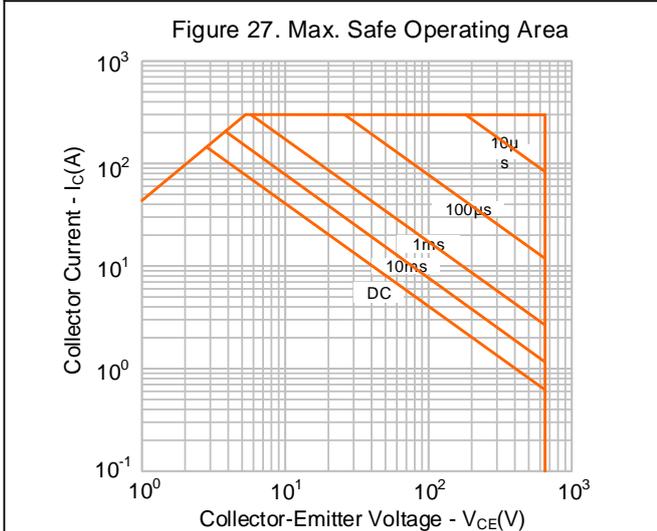
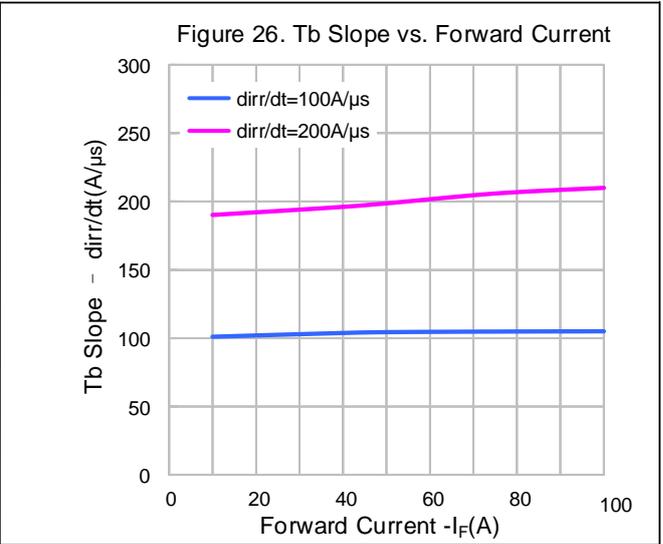
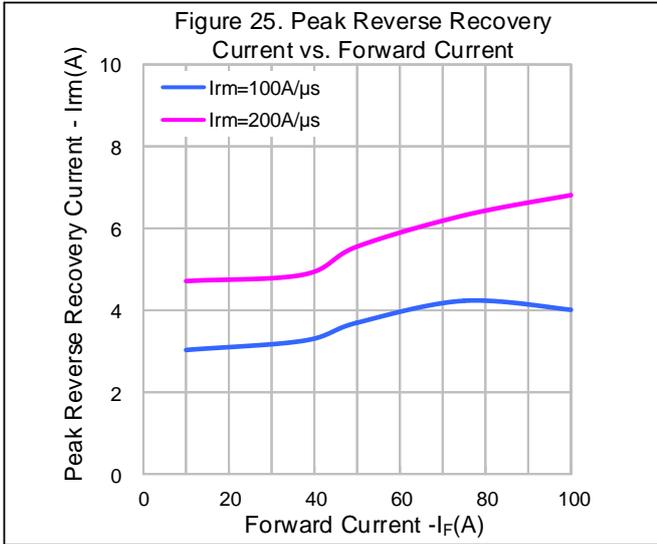
**TYPICAL CHARACTERISTICS (CONTINUED)**



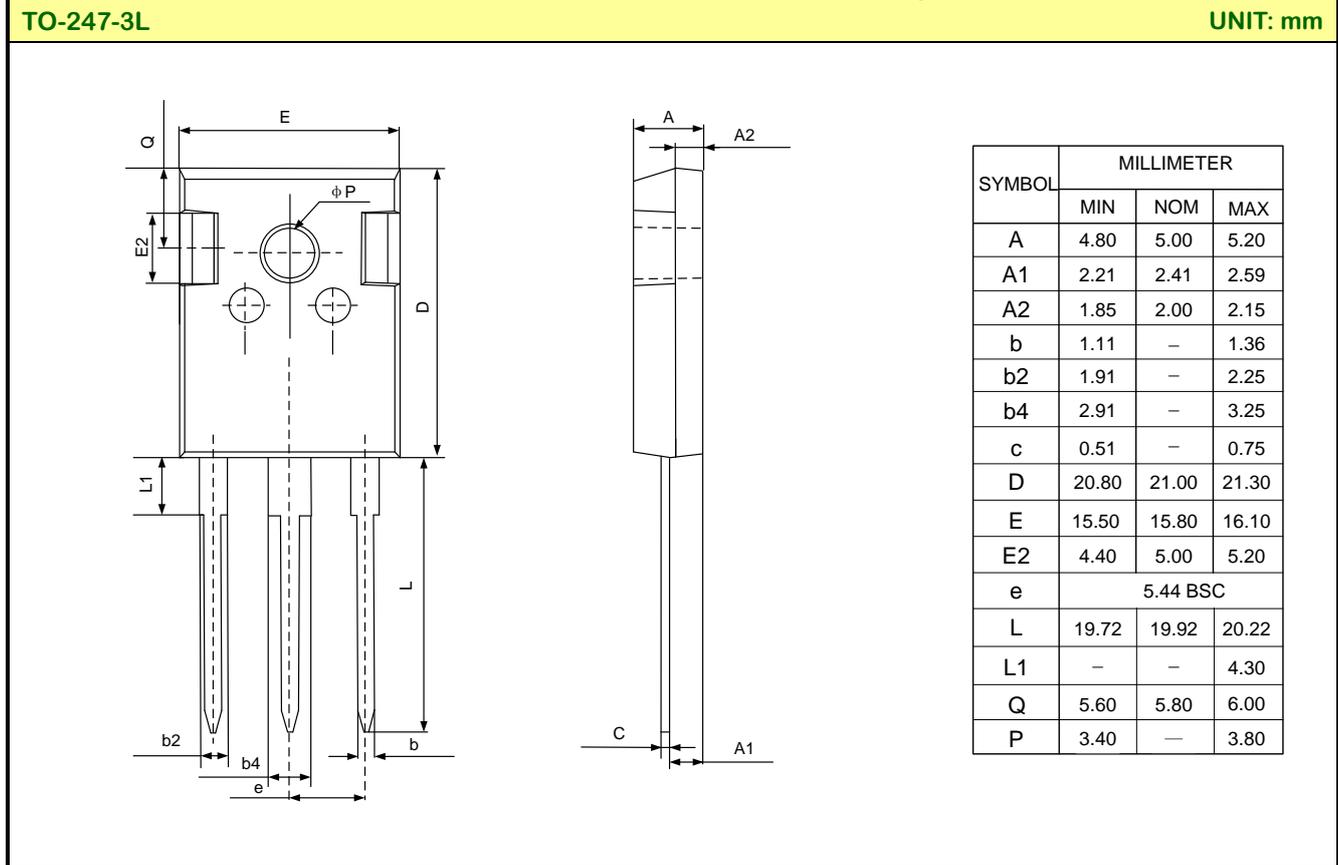
**TYPICAL CHARACTERISTICS (CONTINUED)**



**TYPICAL CHARACTERISTICS (CONTINUED)**



**PACKAGE OUTLINE**



**MOS DEVICES OPERATE NOTES:**

Electrostatic charges may exist in many things. Please take following preventive measures to prevent effectively the MOS electric circuit as a result of the damage which is caused by discharge:

- The operator must put on wrist strap which should be earthed to against electrostatic.
- Equipment cases should be earthed.
- All tools used during assembly, including soldering tools and solder baths, must be earthed.
- MOS devices should be packed in antistatic/conductive containers for transportation.

## Important notice :

1. Silan reserves the right to make changes of this instruction without notice.
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Rev.: 1.1

Revision History:

1. Modify  $P_D$  and  $R_{\theta JC}$  and update corresponding typical characteristics
  2. Update the important notice
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Rev.: 1.0

Revision History:

1. First release
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